A3907

## Low Voltage Voice Coil Motor Driver

## Features and Benefits

- WLCSP package for minimum footprint
- Ramp control circuit
- Fixed I ${ }^{2} \mathrm{C}$ logic thresholds
- 10-bit D-to-A converter
- $100 \mu \mathrm{~A}$ resolution
- Low voltage $I^{2} \mathrm{C}$ serial interface
- Low current draw sleep mode-active low
- 2.3 to 5.5 V operation


## Applications:

- Camera focus motor


## Description <br> Description

Designed for linear control of small form factor voice coil motors, the A3907 is capable of peak output currents to 102 mA and operating voltages to 5.5 V .

Internal circuit protection includes thermal shutdown with hysteresis, flyback clamp diode, and undervoltage monitoring of $V_{D D}$.

## Package: 6-Bump Chip Scale Package (suffix CG)



Functional Block Diagram


Selection Guide

| Part Number | Packing | Package | Pb-free |
| :---: | :---: | :--- | :--- |
| A3907ECGTR | 4000 pieces per reel | Bumped wafer-level chip-scale package <br> (WLCSP) | Pb-free chip with high-temperature solder <br> balls (RoHS compliant) |

## Absolute Maximum Ratings

| Characteristic | Symbol | Notes | Rating | Unit |
| :--- | :---: | :---: | :---: | :---: |
| Supply Voltage | $\mathrm{V}_{\mathrm{DD}}$ |  | 6 | V |
| Logic Input Voltage Range | $\mathrm{V}_{\mathrm{IN}}$ |  | -0.3 to $\mathrm{V}_{\mathrm{DD}}+0.3$ | V |
| Operating Ambient Temperature | $\mathrm{T}_{\mathrm{A}}$ | Range E | -40 to 85 | ${ }^{\circ} \mathrm{C}$ |
| Junction Temperature | $\mathrm{T}_{\mathrm{J}}(\max )$ |  | 150 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | $\mathrm{T}_{\text {stg }}$ |  | -40 to 150 | ${ }^{\circ} \mathrm{C}$ |

Thermal Characteristics

| Characteristic | Symbol | Test Conditions* | Value | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Package Thermal Resistance | $\mathrm{R}_{\text {өJA }}$ | On 4-layer PCB based on JEDEC standard | 64 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

*Additional thermal information available on the Allegro website


| Pin Name | Pin Description |  |
| :--- | :--- | :---: |
| IOUT | Sink Drive Output | A1 |
| SLEEPZ | Standby Mode Control | A2 |
| GND | Ground | B1 |
| SDA | $1^{2}$ C data | B2 |
| VDD | Power Supply In | C1 |
| SCL | $1^{2}$ C clock | C2 |

ELECTRICAL CHARACTERISTICS Valid at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=2.3$ to 5.5 V ; unless otherwise noted

| Characteristics | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Supply Current | $\mathrm{I}_{\mathrm{DD}}$ |  | - | 0.5 | 2 | mA |
|  |  | Sleep Mode (SLEEPZ = low), $\mathrm{V}_{\mathrm{DD}}=2.3$ to 3.5 V | - | < 100 | 500 | nA |
| UVLO Enable Threshold | $\mathrm{V}_{\text {UVLO(th) }}$ | $V_{D D}$ rising | - | 2 | 2.295 | V |
| UVLO Hysteresis | $\mathrm{V}_{\text {UVLI (hys) }}$ |  | - | 100 | - | mV |
| Thermal Shutdown Temperature | $\mathrm{T}_{\text {JTSD }}$ | Temperature increasing | - | 165 | - | ${ }^{\circ} \mathrm{C}$ |
| Thermal Shutdown Hysteresis | $\mathrm{T}_{\text {JTSD (hys) }}$ | Recovery $=\mathrm{T}_{\text {JTSD }}-\mathrm{T}_{\text {JTSD(hys) }}$ | - | 15 | - | ${ }^{\circ} \mathrm{C}$ |
| Power-Up Delay | $\mathrm{t}_{\mathrm{dPO}}$ |  | - | 10 | - | $\mu \mathrm{s}$ |
| D-to-A Converter |  |  |  |  |  |  |
| Resolution | Res | Target $=100 \mu \mathrm{~A} / \mathrm{LSB}$ | - | 10 | - | bit |
| Relative Accuracy | $\mathrm{errI}_{\text {INL }}$ | Code = 64 to 1023, Endpoint method | - | $\pm 4$ | - | LSB |
| Differential Nonlinearity | $\mathrm{err}_{\text {DNL }}$ | Guaranteed monotonic | - | - | $\pm 1$ | LSB |
| Maximum Output Current | $\mathrm{I}_{\text {MAX }}$ | Code = 1023 | - | 102.3 | - | mA |
| Gain Error | $\operatorname{err}_{\text {A }}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$, Code 64 to $1023, \mathrm{~V}_{\mathrm{DD}}=2.6$ to 3.0 V | -10 | < 3 | 10 | \%FS |
| Gain Error Drift ${ }^{1}$ | $\Delta \mathrm{err}_{\mathrm{A}}$ | $\mathrm{T}_{\mathrm{J}}=-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ | - | 0.2 | - | LSB/ ${ }^{\circ} \mathrm{C}$ |
| Minimum Code Error | los1 | Code $=1$ | 0 | 1 | 5 | mA |
| Offset Error | los | Code $=64$ | - | 0.5 | - | mA |
| Output |  |  |  |  |  |  |
| Slew Rate Timer | $\mathrm{err}_{\text {TS }}$ | Relative to target value | -10 | - | 10 | \% |
| Output Voltage Range | $\mathrm{V}_{\text {OUT }}$ |  | 0.35 | - | $\mathrm{V}_{\mathrm{DD}}-0.1$ | V |
| Output On Resistance | $\mathrm{R}_{\mathrm{DS} \text { (on) }}$ | $\mathrm{R}_{\text {SENSE }}+\mathrm{R}_{\text {SINK }}, \mathrm{I}_{\text {OUT }}=102.3 \mathrm{~mA}$ | - | 2 | - | $\Omega$ |
| $1^{2} \mathrm{C}$ Interface |  |  |  |  |  |  |
| Bus Free Time Between Stop and Start | $\mathrm{t}_{\text {BUF }}$ |  | 1.3 | - | - | $\mu \mathrm{s}$ |
| Hold Time Start Condition | $\mathrm{t}_{\text {HD: }}$ STA |  | 0.6 | - | - | $\mu \mathrm{s}$ |
| Setup Time for Repeated Start Condition | $\mathrm{t}_{\text {SU:STA }}$ |  | 0.6 | - | - | $\mu \mathrm{s}$ |
| SCL Low Time | tow |  | 1.3 | - | - | $\mu \mathrm{s}$ |
| SCL High Time | $\mathrm{t}_{\text {HIGH }}$ |  | 0.6 | - | - | $\mu \mathrm{s}$ |
| Data Setup Time | $\mathrm{t}_{\text {SU:DAT }}$ |  | 100 | - | - | ns |
| Data Hold Time | $\mathrm{t}_{\text {HD: DAT }}$ |  | 0 | 900 | - | ns |

ELECTRICAL CHARACTERISTICS (continued) Valid at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=2.3$ to 5.5 V ; unless otherwise noted

| Characteristics | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ${ }^{12} \mathrm{C}$ Interface |  |  |  |  |  |  |
| Setup Time for Stop Condition | $\mathrm{t}_{\text {SU:STO }}$ |  | 0.6 | - | - | $\mu \mathrm{s}$ |
| Logic Input (SDA, SCL Pins) Low Level | $\mathrm{V}_{\mathrm{IL}}$ |  | - | - | 0.84 | V |
| Logic Input (SDA, SCL Pins) High Level | $\mathrm{V}_{\mathrm{IH}}$ |  | 1.26 | - | - | V |
| $\overline{\text { SLEEP Pin Input Low Level }}$ | $\mathrm{V}_{\text {SLPINL }}$ |  | - | - | 0.7 | V |
| $\overline{\text { SLEEP Pin Input High Level }}$ | $\mathrm{V}_{\text {SLPINH }}$ |  | 1.5 | - | - | V |
| Input Hysteresis | $\mathrm{V}_{\mathrm{HYS}}$ | SDA and SCL only | - | 100 | - | mV |
| Logic Input Current | $\mathrm{I}_{\text {IN }}$ | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}$ | -1 | 0 | 1 | $\mu \mathrm{A}$ |
| SDA Pin Output Voltage | $\mathrm{V}_{\text {OL }}$ | $\mathrm{I}_{\text {LOAD }}=1.5 \mathrm{~mA}$ | - | - | 0.36 | V |
| SCL Clock Frequency | $\mathrm{f}_{\text {CLK }}$ |  | - | - | 400 | kHz |
| SDA Output Fall Time | $\mathrm{t}_{\mathrm{OF}}$ | $\mathrm{V}_{\mathrm{IH}}$ to $\mathrm{V}_{\text {IL }}$ | - | - | 250 | ns |

${ }^{1}$ Assured by design and characterization, not production tested.
${ }^{12} \mathrm{C}$ Timing Diagram


## Functional Description

## Output Current Level Control

The A3907 output current level, $\mathrm{I}_{\mathrm{OUT}}$, is controlled dynamically by programming the D-to-A converter (DAC) value via the $\mathrm{I}^{2} \mathrm{C}$ serial port. A 10-bit Level Control code, having a decimal equivalent value from 0 through 1023, is clocked into the SDA pin.

The target output current can be calculated by:

$$
\begin{equation*}
I_{\mathrm{OUT}}=n_{\mathrm{DAC}} \times 100 \mu \mathrm{~A} \tag{1}
\end{equation*}
$$

where $n_{\text {DAC }}$ is the decimal equivalent of the Level Control code. For example, a code of $5\left(00000101_{2}\right)$ sets an output current target of $500 \mu \mathrm{~A}$.

Programming Level Control code 0 disables the output sink drive. In addition, the DAC is automatically set to code 0 at power-up and also at a fault condition on VDD.

## Output Current Slew Rate Control

When a new current level control instruction is received on the SDA input, the A3907 moves to the new target currrent level by incrementing or decrementing through each of the intermediate current levels until it arrives at the new programmed value.
The control instruction received at the SDA input includes both the 10-bit Level Control code and a 4-bit Ramp Control code. The Level Control code is used to determine the absolute value of the changes in $\mathrm{I}_{\text {OUT }}$ (see equation 1), and the Ramp Control code maps to a lookup table of time intervals (represented in table 1). Together, these two codes determine the shape of the current level change function.

Step or Ramp Function The A3907 can change to the new target level using either a step or a ramp slew rate function. When a step function is selected, the A3907 moves to the new target level without imposing any additional time delays between DAC updates. To select a step function, program one of the four Ramp Control codes in table 1 that disable the ramp feature.
When a ramp function is selected, the A3907 imposes time delays between each DAC update, calculated according to the particular function option selected. To select a ramp function, program one of the twelve Ramp Control codes in table 1 that enable the ramp feature.

Single or Dual Subintervals For either the step or the ramp slew rate method, the total change can be accomplished in either
one continuous time interval, or divided over two sequential time subintervals. When the single-interval method is selected, the total change in $\mathrm{I}_{\text {OUT }}$ is accomplished over the total time interval determined by the Rate Control code in table 1, calculated as follows:

$$
\begin{equation*}
\operatorname{Code}_{\mathrm{T}}=\left|\left(\operatorname{Code}_{\text {NewTarget }}-\operatorname{Code}_{\text {PreviousTarget }}\right)\right| / 2 \tag{2}
\end{equation*}
$$

and

$$
\begin{equation*}
\mathrm{T}=\operatorname{Code}_{\mathrm{T}} \times t_{\mathrm{dT}} \tag{3}
\end{equation*}
$$

where $t_{d T}$ is the delay factor, in table 1 .
When the dual-subintervals method is selected, the elapsed time for each subinterval is determined separately by the Rate Control code in table 1. The time interval from initiation, T0, to the switchover point, T 1 , is calculated as follows:

$$
\begin{equation*}
\text { Code }_{\text {Switchover }}=\mid\left(\text { Code }_{\text {NewTarget }}-\operatorname{Code}_{\text {PreviousTarget }}\right) \mid / 2, \tag{4}
\end{equation*}
$$

and

$$
\begin{equation*}
\mathrm{T} 1=\operatorname{Code}_{\mathrm{Switchover}} \times t_{\mathrm{dT} 1} \tag{5}
\end{equation*}
$$

where $\mathrm{t}_{\mathrm{dT} 1}$ is the delay factor for the initial time subinterval, in table 1.

The current amplitude at the switchover point is calculated based on equation 1 , as follows:

$$
\begin{equation*}
I_{\text {Switchover }}=\left(\operatorname{Code}_{\text {Low }}+\operatorname{Code}_{\text {Switchover }}\right) \times 100 \mu \mathrm{~A}, \tag{6}
\end{equation*}
$$

where Code $_{\text {Low }}$ is the lesser of Code ${ }_{\text {NewTarget }}$ and Code PreviousTarget .
The time interval from the switchover point, T 1 , until the target current level is reached, T2, is calculated as follows:

$$
\begin{equation*}
\mathrm{T} 2-\mathrm{T} 1=\operatorname{Code}_{\text {Switchover }} \times t_{\mathrm{dT} 2} \tag{7}
\end{equation*}
$$

where $t_{d T 2}$ is the delay factor for the second time subinterval, in table 1.

## Output Function Programming

Two examples of output level and slew rate programming are shown in figure 1. Both examples are ramp slew rate functions, using the dual-subinterval method. In example A , an increment in $\mathrm{I}_{\mathrm{OUT}}$ is shown, and example B shows a decrement in $\mathrm{I}_{\mathrm{OUT}}$.

## Example A

- The A3907 has been previously programmed to Level Control code $100\left(1100100_{2}\right)$, for a target $\mathrm{I}_{\text {OUT }}$ of $100 \times 100 \mu \mathrm{~A}$ $=10 \mathrm{~mA}$ (equation 1 ).
- The new target current level is 20 mA , so Level Control code $200\left(11001000_{2}\right)$ is programmed (invert equation 1$)$.
- For this example, the slew rate function selected is represented by Ramp Control code $1100_{2}$ : ramp, dual-subinterval, initial subinterval delay factor 781 ns , second subinterval delay factor $50 \mu \mathrm{~s}$.
- The A3907 determines the switchover point, T1, as follows:

Code $_{\text {Switchover }}=|(200-100)| / 2=50$ (equation 2),
$\mathrm{T} 1=50 \times 0.781 \mu \mathrm{~s}=39 \mu \mathrm{~s}$ (equation 5 ),
$I_{\mathrm{T} 1}=50+100 \times 100 \mu \mathrm{~A}=150 \mu \mathrm{~A}$ (equation 6).

- The A3907 determines the target time final point, T2, as follows: Code $_{\text {Switchover }}=|(200-100)| / 2=50$ (equation 2),
$\mathrm{T} 2-\mathrm{T} 1=50 \times 50 \mu \mathrm{~s}=2.5 \mathrm{~ms}$ (equation 5 ).


## Example B

- The A3907 has been previously programmed to Level Control code $1000\left(1111101000_{2}\right)$, for a target $\mathrm{I}_{\text {OUT }}$ of $1000 \times 100 \mu \mathrm{~A}$ $=100 \mathrm{~mA}$ (equation 1 ).

Table 1. Slew Rate Function Table

| Slew Rate Method | Timer Bits Settings |  |  |  | Delay Factor ( $\mu \mathrm{s}$ ) |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | T3 | T2 | T1 | T0 | $\mathrm{t}_{\mathrm{dT}}$ |  |
| Single Interval | 0 | 0 | 0 | 0 | 0 (ramp feature disabled) |  |
|  | 0 | 0 | 0 | 1 | 6.25 |  |
|  | 0 | 0 | 1 | 0 | 12.5 |  |
|  | 0 | 0 | 1 | 1 | 25 |  |
|  | 0 | 1 | 0 | 0 | 50 |  |
|  | 0 | 1 | 0 | 1 | 100 |  |
|  | 0 | 1 | 1 | 0 | 200 |  |
|  | 0 | 1 | 1 | 1 | 0 (ramp feature disabled) |  |
| Dual Interval | T3 | T2 | T1 | T0 | $\mathrm{t}_{\mathrm{dT} 1}$ | $\mathrm{t}_{\mathrm{d} 2}$ |
|  | 1 | 0 | 0 | 0 | 0 (ramp feature disabled) |  |
|  | 1 | 0 | 0 | 1 | 0.781 | 6.25 |
|  | 1 | 0 | 1 | 0 |  | 12.5 |
|  | 1 | 0 | 1 | 1 |  | 25 |
|  | 1 | 1 | 0 | 0 |  | 50 |
|  | 1 | 1 | 0 | 1 |  | 100 |
|  | 1 | 1 | 1 | 0 |  | 200 |
|  | 1 | 1 | 1 | 1 | 0 (ramp feature disabled) |  |

- The new target current level is 30 mA , so Level Control code $300\left(100101100_{2}\right)$ is programmed (invert equation 1).
- For this example, the slew rate function selected is represented by Ramp Control code $1101_{2}$ : ramp, dual-subinterval, initial subinterval delay factor 781 ns , second subinterval delay factor $100 \mu \mathrm{~s}$.
- The A3907 determines the switchover point, T2, as follows:

$$
\text { Code } \left._{\text {Switchover }}=|(1000-300)| / 2=350 \text { (equation } 2\right),
$$

$$
\begin{aligned}
& \mathrm{T} 1=350 \times 0.781 \mu \mathrm{~s}=273 \mu \mathrm{~s}(\text { equation } 5) \\
& I_{\mathrm{T} 1}=350+300 \times 100 \mu \mathrm{~A}=65 \mu \mathrm{~A}(\text { equation } 6)
\end{aligned}
$$

- The A3907 determines the target time final point, T1, as follows: Code $_{\text {Switchover }}=|(1000-300)| / 2=350$ (equation 2),
$\mathrm{T} 2-\mathrm{T} 1=350 \times 100 \mu \mathrm{~s}=35 \mathrm{~ms}$ (equation 5).



Figure 1. Examples of programmed $\mathrm{I}_{\mathrm{OUT}}$ change

## Low Voltage Voice Coil Motor Driver

## ${ }^{12}$ C Interface

This is a serial interface that uses two bus lines, SCL and SDA, to access the internal control registers. Data is exchanged between a microcontroller (master) and the A3907 (slave). The clock input to SCL is generated by the master, while SDA functions as either an input or an open drain output, depending on the direction of the data. The $\mathrm{I}^{2} \mathrm{C}$ input thresholds do not depend on the VDD voltage of the A3907. The levels are fixed at approximately 1 V . The fixed levels allow the SDA and SCL lines to be pulled-up to a different logic level than the VDD supply of the 3907.
Timing Considerations The control sequence of the communication through the $\mathrm{I}^{2} \mathrm{C}$ interface is composed of several steps in sequence:

1. Start Condition. Defined by a negative edge on the SDA line, while SCL is high.
2. Address Cycle. 7 bits of address, plus 1 bit to indicate write (0) or read(1), and an acknowledge bit. The address setting is $0 \times 18$, $0 \times 1 \mathrm{~A}, 0 \times 1 \mathrm{C}$, or $0 \times 1 \mathrm{E}$.
3. Data Cycles. Write requires 7 bits of address data selecting the internal control register, followed by an acknowledge bit.
4. Stop Condition. Defined by a positive edge on the SDA line, while SCL is high.

Except to indicate a Start or Stop condition, SDA must be stable while the clock is high. SDA can only be changed while SCL is low. It is possible for the Start or Stop condition to occur at any time during a data transfer. The A3907 always responds by resetting the data transfer sequence.
To indicate a write cycle, the Read/Write bit is set to low. Mulitple writes are allowed. If desired, the readback bit can be set to high to check what was last written.
The Acknowledge bit is used by the master to determine if the slave device is responding to its address and data transmissions. When the A3907 decodes the 7-bit address field as a valid address, it responds by pulling SDA low during the ninth clock cycle.
During a data write from the master, the A3907 pulls SDA low during the clock cycle that follows the last data byte, in order to indicate that the data has been successfully received. In both cases, the master device must release the SDA line before the ninth clock cycle, in order to allow this handshaking to occur.

Slave (A3907) Address

| Device Identifier |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 1 | 1 | X | X | 0 |

## Control Register MS Byte ( ${ }^{2} \mathrm{C}$ Write register)

| Bit | Name | Function |
| :---: | :---: | :---: |
| 0 | D4 | DAC |
| 1 | D5 | DAC |
| 2 | D6 | DAC |
| 3 | D7 | DAC |
| 4 | D8 | DAC |
| 5 | D9 | DAC MSB |
| 6 | T5 | Not used |
| 7 | SLEEP | 1=Sleep 0=Normal |

Control Register MS Byte (I2C Write register)

| Bit | Name | Function |
| :---: | :---: | :---: |
| 0 | T0 | Time Setting LSB |
| 1 | T1 | Time Setting Bit 1 |
| 2 | T2 | Time Setting Bit2 |
| 3 | T3 | Time Setting Bit 3 |
| 4 | D0 | DAC LSB |
| 5 | D1 | DAC |
| 6 | D2 | DAC |
| 7 | D3 | DAC |

## Write Operation



## Output Voltage Range

To guarantee the accuracy and linearity of the programmed current, the voltage on the IOUT pin, $\mathrm{V}_{\text {OUT }}$, should be greater than 350 mV . The output voltage is a function of the battery voltage, motor resistance, and the programmed load current, $\mathrm{I}_{\text {OUT }}$.

## Clamp Diode

When the IC output is turned off, the load inductance causes the
output voltage, $\mathrm{V}_{\text {OUT }}$, to rise. An internal clamp diode, connected between the IOUT and VDD pins, is integrated into the IC to ensure the output voltage remains at a safe level.

## SLEEP Pin

The $\overline{\text { SLEEP }}$ pin is an active low input. A logic low signal disables all of the internal circuitry and prevents the IC from draining battery power.

## Applications Information

## Headroom

The current may not reach the programmed level if there is not adequate headroom in the output circuit. The IC output voltage must be over 350 mV to guarantee normal linear operation. $\mathrm{V}_{\mathrm{DD}}$, $\mathrm{I}_{\text {LOAD }}$, and $\mathrm{R}_{\text {LOAD }}$ can be adjusted to ensure the device operates in the linear range. When equation 7 is not satisfied, the load current will be limited by the series impedance and may not reach the programmed level.

$$
\begin{equation*}
V_{\mathrm{DD}}(\min )-R_{\mathrm{LOAD}}(\max ) \times I_{\mathrm{OUT}}(\max ) \geq 350 \mathrm{mV} . \tag{7}
\end{equation*}
$$

$I_{\text {Out }}$ Errors Defined
Relative Accuracy (INL) This error is calculated by measuring the worse case deviation from a straight line defined from endpoints. The straight line endpoints are defined by the actual measured values at Level Control code 63 and 1023 (see figure 2).

Differential Nonlinearity (DNL) A measure of the monotonicity of the DAC (see equation 8). The slope of the line must
always be positive for each incremental step.

$$
\begin{equation*}
\mathrm{DNL}=\left(I_{\mathrm{OUT}}(n+1)-I_{\mathrm{OUT}}(n)\right) / \mathrm{LSB}, \tag{8}
\end{equation*}
$$

where ( $\mathrm{n}=64$ to 1023). DNL should be $<1 \mathrm{LSB}$.
Offset Error The measured output current at Level Control code 64 , compared to the ideal value according to the transfer function: 6.4 mA .

Gain Error The difference between the slopes of the ideal transfer function and the actual transfer function. The gain error is calculated by subtracting the offset error at Level Control code 16 from the actual transfer function. This calculated value is compared to the ideal transfer function and reported as a percentage of the ideal full scale value: 102.3 mA (see figure 3).

Gain Error Drift The change in slope of the transfer function due to temperature, expressed as LSB $/{ }^{\circ} \mathrm{C}$.


Figure 2. Relative Accuracy


Figure 3. Gain Error

## Low Voltage Voice Coil Motor Driver

CG Package, 6-Ball WLCSP


Copyright ©2009-2013, Allegro MicroSystems, LLC
Allegro MicroSystems, LLC reserves the right to make, from time to time, such departures from the detail specifications as may be required to permit improvements in the performance, reliability, or manufacturability of its products. Before placing an order, the user is cautioned to verify that the information being relied upon is current.
Allegro's products are not to be used in life support devices or systems, if a failure of an Allegro product can reasonably be expected to cause the failure of that life support device or system, or to affect the safety or effectiveness of that device or system.
The information included herein is believed to be accurate and reliable. However, Allegro MicroSystems, LLC assumes no responsibility for its use; nor for any infringement of patents or other rights of third parties which may result from its use.

For the latest version of this document, visit our website:
www.allegromicro.com

